

SEMICONDUCTOR TM

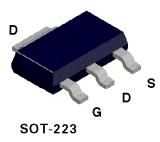
# NDT451AN N-Channel Enhancement Mode Field Effect Transistor

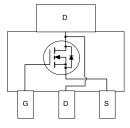
### **General Description**

Power SOT N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in-line power loss, and resistance to transients are needed.

# Features

- 7.2A, 30V.  $R_{DS(ON)} = 0.035\Omega @ V_{GS} = 10V$  $R_{DS(ON)} = 0.05\Omega @ V_{GS} = 4.5V.$
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.



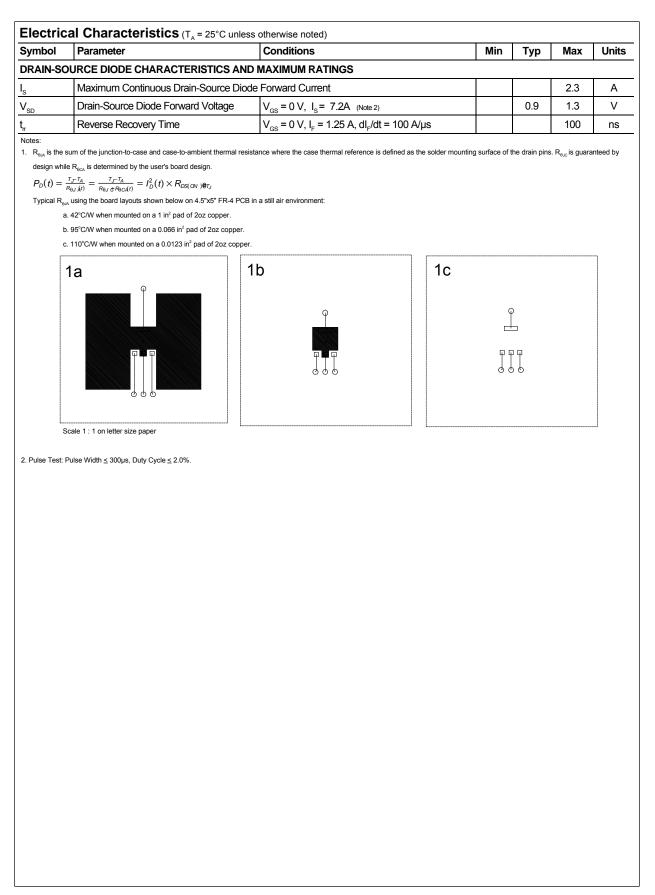


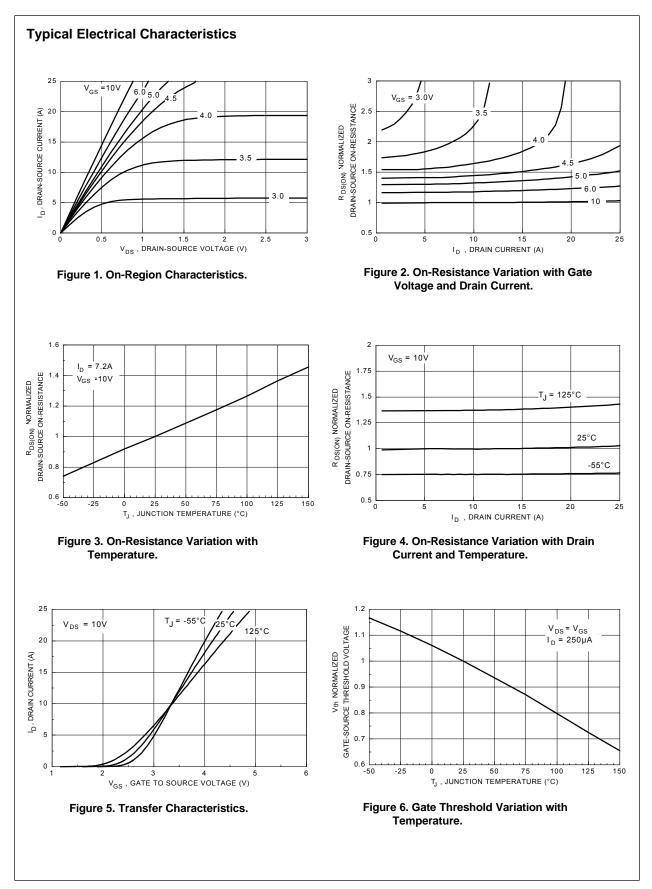
# **Absolute Maximum Ratings** T<sub>4</sub>= 25°C unless otherwise noted

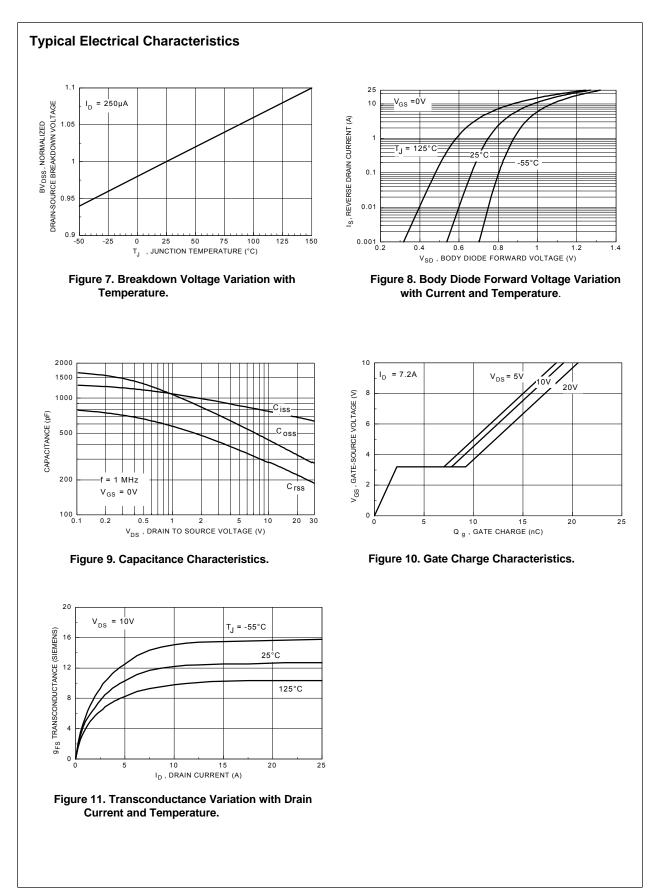
Symbol	Parameter		NDT451AN	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V
I <sub>D</sub>	Drain Current - Continuous	(Note 1a)	±7.2	А
	- Pulsed		± 25	
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	3	W
		(Note 1b)	1.3	
		(Note 1c)	1.1	
T_,T <sub>stg</sub>	Operating and Storage Temperature Range		-65 to 150	°C
THERMA	L CHARACTERISTICS			
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Amb	ient (Note 1a)	42	°C/W
R <sub>øJC</sub>	Thermal Resistance, Junction-to-Case	e (Note 1)	12	°C/W

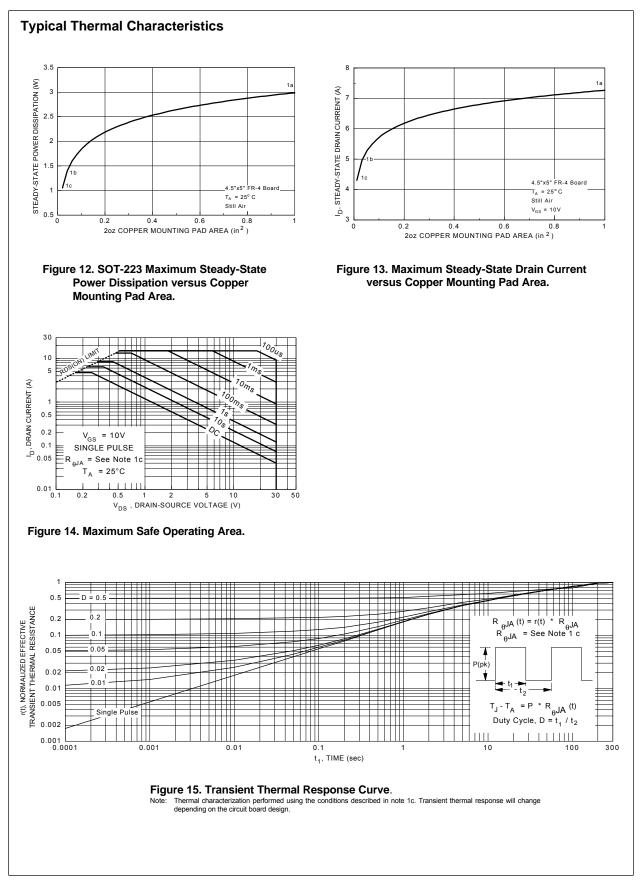
February 2009

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 µA		30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V				1	μA
			T <sub>J</sub> = 55°C			10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-			100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.6	3	V
			T <sub>J</sub> = 125°C	0.7	1.2	2.2	
R <sub>ds(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.2 A			0.03	0.035	Ω
			T <sub>J</sub> = 125°C		0.042	0.063	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 6.0 \text{ A}$			0.042	0.05	
			T <sub>J</sub> = 125°C		0.058	0.09	
l <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$		25			Α
		$V_{GS} = 4.5 V, V_{DS} = 5 V$		15			
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 7.2 \text{ A}$			11		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			720		pF
C <sub>oss</sub>	Output Capacitance				370		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				250		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{\rm DD} = 10 \text{ V}, \text{ I}_{\rm D} = 1 \text{ A}, \\ V_{\rm GEN} = 10 \text{ V}, \text{ R}_{\rm GEN} = 6 \Omega$			12	20	ns
ţ,	Turn - On Rise Time				13	30	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				29	50	ns
t <sub>r</sub>	Turn - Off Fall Time				10	20	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 10 \text{ V},$ $I_D = 7.2 \text{ A}, V_{GS} = 10 \text{ V}$			19	30	nC
Q <sub>gs</sub>	Gate-Source Charge				2.3		nC
Q <sub>gd</sub>	Gate-Drain Charge				5.5		nC











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